



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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NTJD2152P

Trench Small Signal MOSFET

8 V, Dual P-Channel, SC-88

ESD Protection

Features

- Leading -8 V Trench for Low $R_{DS(ON)}$ Performance
- ESD Protected Gate
- Small Footprint (2 x 2 mm)
- Same Package as SC-70-6
- Pb-Free Packages are Available

Applications

- Load Power switching
- DC-DC Conversion
- Li-Ion Battery Charging Circuits
- Cell Phones, Media Players, Digital Cameras, PDAs

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise stated)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V_{DSS}	-8.0	V	
Gate-to-Source Voltage		V_{GS}	± 8.0	V	
Continuous Drain Current (Based on $R_{\theta JA}$)	Steady State	I_D	$T_A = 25^\circ\text{C}$	-0.775	A
			$T_A = 85^\circ\text{C}$	-0.558	
Power Dissipation (Based on $R_{\theta JA}$)	Steady State	P_D	$T_A = 25^\circ\text{C}$	0.27	W
			$T_A = 85^\circ\text{C}$	0.14	
Continuous Drain Current (Based on $R_{\theta JL}$)	Steady State	I_D	$T_A = 25^\circ\text{C}$	-1.1	A
			$T_A = 85^\circ\text{C}$	-0.8	
Power Dissipation (Based on $R_{\theta JL}$)	Steady State	P_D	$T_A = 25^\circ\text{C}$	0.55	W
			$T_A = 85^\circ\text{C}$	0.29	
Pulsed Drain Current		$t \leq 10 \mu\text{s}$	I_{DM}	± 1.2	A
Operating Junction and Storage Temperature		T_J, T_{STG}	-55 to 150		$^\circ\text{C}$
Continuous Source Current (Body Diode)		I_S	-0.775		A
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		T_L	260		$^\circ\text{C}$

THERMAL RESISTANCE RATINGS (Note 1)

Parameter	Symbol	Typ	Max	Unit
Junction-to-Ambient - Steady State	$R_{\theta JA}$	400	460	$^\circ\text{C}/\text{W}$
Junction-to-Lead (Drain) - Steady State	$R_{\theta JL}$	194	226	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 oz Cu area = 0.9523 in sq.

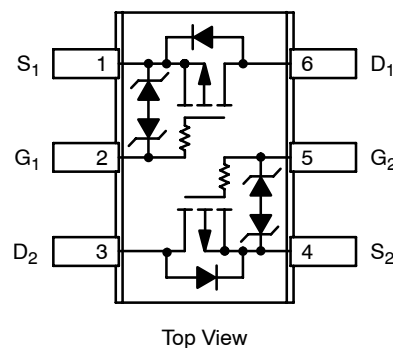


ON Semiconductor®

<http://onsemi.com>

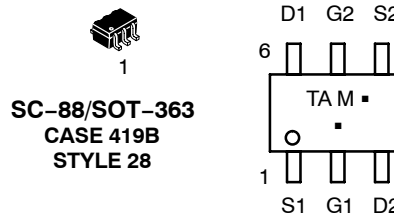
$V_{(BR)DSS}$	$R_{DS(on)}$ TYP	I_D Max
-8 V	0.22 Ω @ -4.5 V	-0.775 A
	0.32 Ω @ -2.5 V	
	0.51 Ω @ -1.8 V	

SOT-363
SC-88 (6 LEADS)



Top View

MARKING DIAGRAM & PIN ASSIGNMENT



SC-88/SOT-363
CASE 419B
STYLE 28

TA = Device Code
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

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ELECTRICAL CHARACTERISTICS (T_J=25°C unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = -250 μA	-8.0	-10.5		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J			-6.0		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -6.4 V			1.0	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±8.0 V			10	μA

ON CHARACTERISTICS (Note 2)

Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = -250 μA	-0.45	-0.83	-1.0	V
Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J			2.2		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = -4.5 V, I _D = -0.57 A		0.22	0.3	Ω
		V _{GS} = -2.5 V, I _D = -0.48 A		0.32	0.46	
		V _{GS} = -1.8 V, I _D = -0.20 A		0.51	0.9	
Forward Transconductance	g _{FS}	V _{GS} = -4.0 V, I _D = -0.57 A		2.0		S

CHARGES AND CAPACITANCES

Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = -8.0 V		160	225	pF
Output Capacitance	C _{OSS}			38	55	
Reverse Transfer Capacitance	C _{RSS}			28	40	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = -4.5 V, V _{DS} = -5.0 V, I _D = -0.6 A		2.2	4.0	nC
Threshold Gate Charge	Q _{G(TH)}			0.1		
Gate-to-Source Charge	Q _{GS}			0.5		
Gate-to-Drain Charge	Q _{GD}			0.5		

SWITCHING CHARACTERISTICS (Note 3)

Turn-On Delay Time	t _{d(ON)}	V _{GS} = -4.5 V, V _{DD} = -4.0 V, I _D = -0.5 A, R _G = 8.0 Ω		13		ns
Rise Time	t _r			23		
Turn-Off Delay Time	t _{d(OFF)}			50		
Fall Time	t _f			36		

DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = -0.23 A	T _J = 25°C	0.76	1.1	V
			T _J = 125°C	0.63		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/μs, I _S = -0.77 A		78		ns

2. Pulse Test: pulse width ≤ 300μs, duty cycle ≤ 2%.
3. Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES ($T_J = 25^\circ\text{C}$ unless otherwise noted)

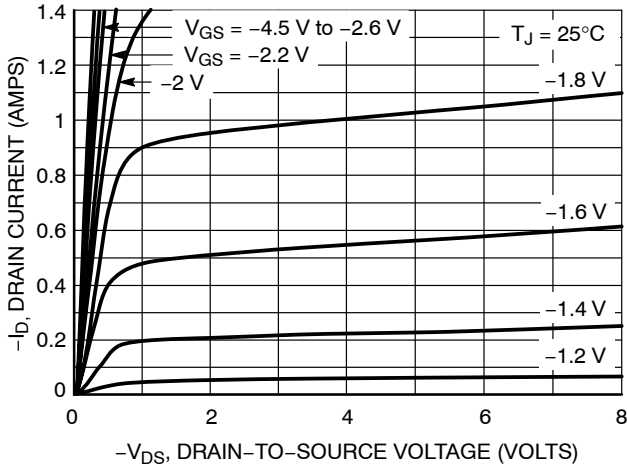


Figure 1. On-Region Characteristics

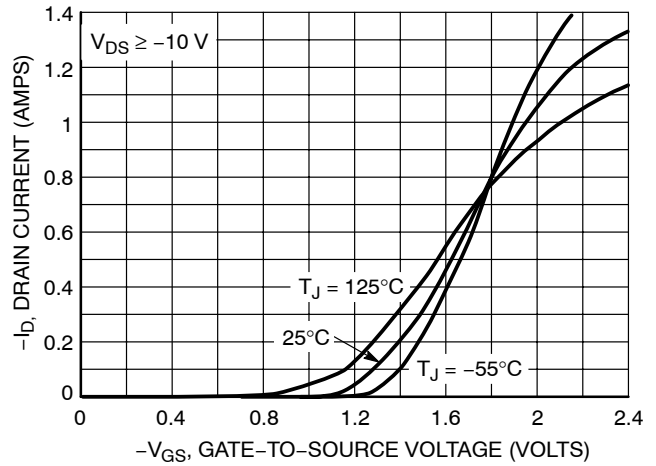


Figure 2. Transfer Characteristics

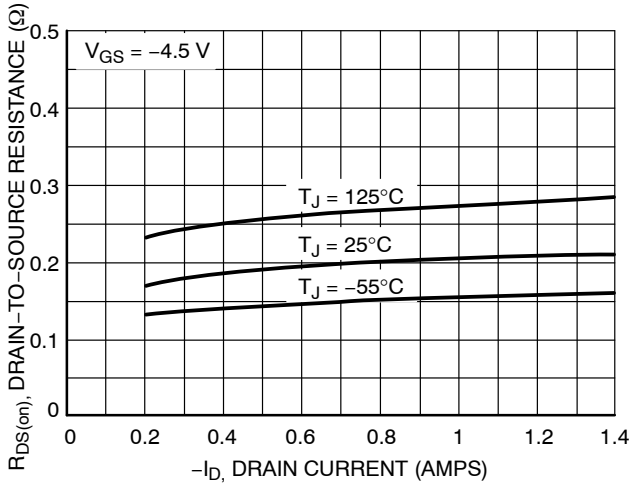


Figure 3. On-Resistance vs. Drain Current and Temperature

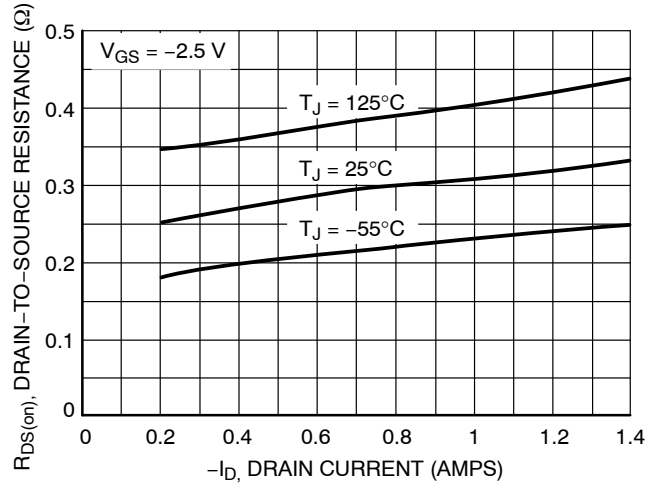


Figure 4. On-Resistance vs. Drain Current and Temperature

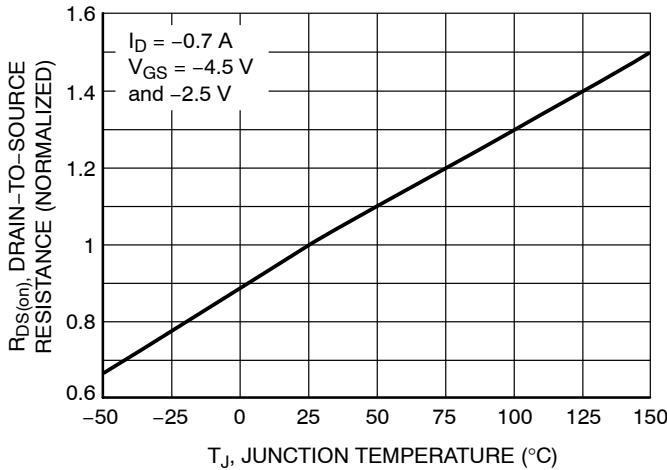


Figure 5. On-Resistance Variation with Temperature

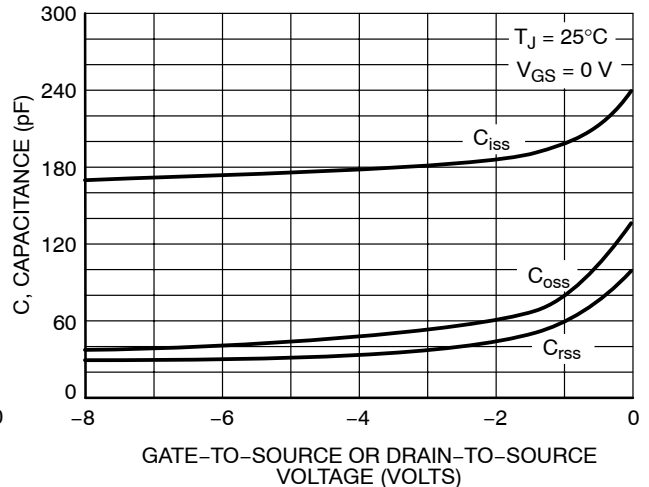


Figure 6. Capacitance Variation

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TYPICAL PERFORMANCE CURVES ($T_J = 25^\circ\text{C}$ unless otherwise noted)

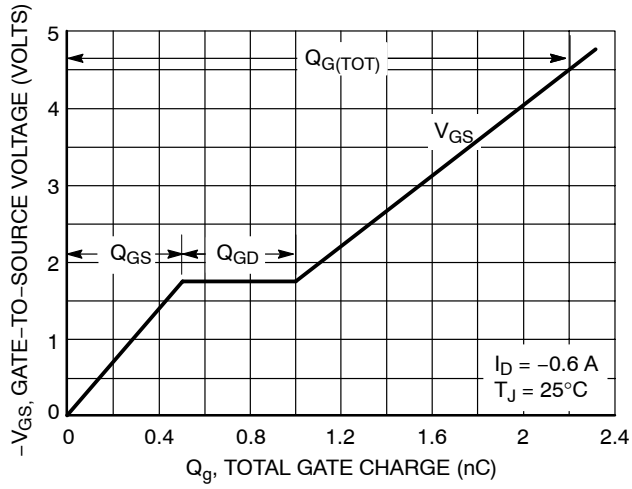


Figure 7. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

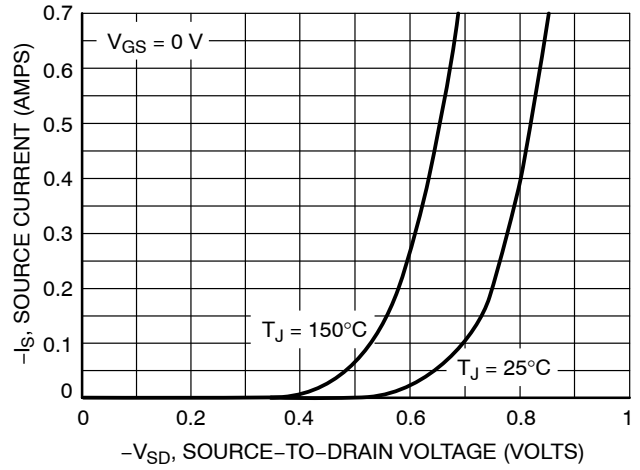


Figure 8. Diode Forward Voltage vs. Current

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ORDERING INFORMATION

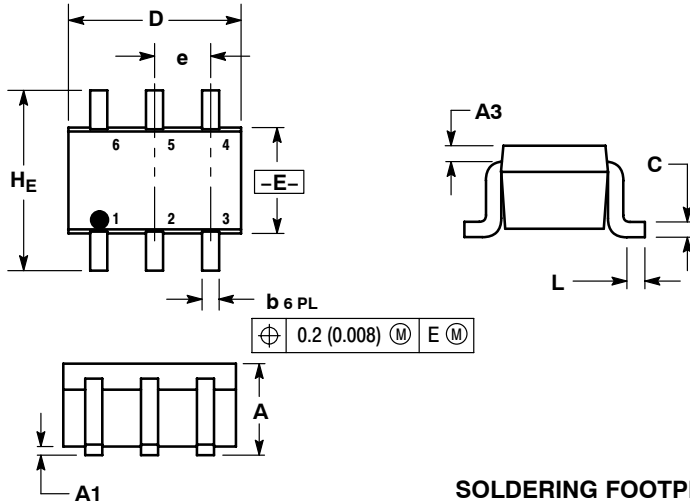
Device Order Number	Package Type	Tape and Reel Size†
NTJD2152PT1	SOT-363	3000 / Tape & Reel
NTJD2152PT1G	SOT-363 (Pb-Free)	3000 / Tape & Reel
NTJD2152PT2	SOT-363	3000 / Tape & Reel
NTJD2152PT2G	SOT-363 (Pb-Free)	3000 / Tape & Reel
NTJD2152PT4	SOT-363	10,000 / Tape & Reel
NTJD2152PT4G	SOT-363 (Pb-Free)	10,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NTJD2152P

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363
CASE 419B-02
ISSUE W



NOTES:

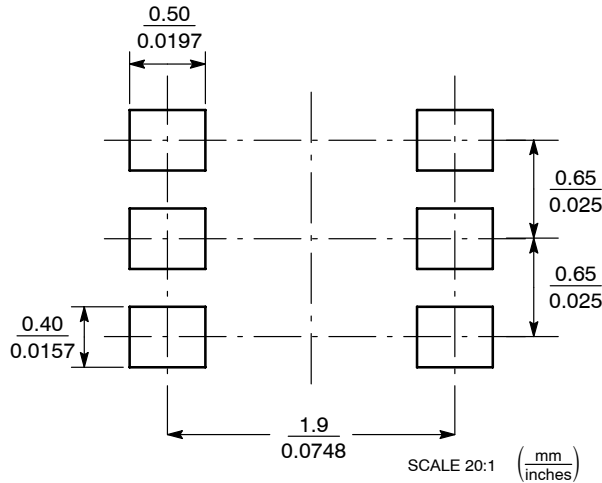
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
C	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e	0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	2.00	2.10	2.20	0.078	0.082	0.086

STYLE 26:

- PIN 1, SOURCE 1
- GATE 1
- DRAIN 2
- SOURCE 2
- GATE 2
- DRAIN 1

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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